

Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it displays a valid OMB control number.

Declaration and Power of Attorney For Patent Application

特許出願宣言書及び委任状

Japanese Language Declaration

日本語宣言書



以下の氏名を発明者として、私は以下の通り宣言します。

As a below named inventor, I hereby declare that:

私の住所、電話番号、国籍は下記の私の氏名の後に記載された通りです。

My residence, post office address and citizenship are as stated next to my name.

下記の名前の発明者に関して請求範囲に記載され、特許出願している発明内容について、私が最初かつ唯一の発明者（下記の氏名が一つの場合）もしくは最初かつ共同発明者であると（下記の氏名が複数の場合）信じています。

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

METHOD OF MANUFACTURING A

SEMICONDUCTOR DEVICE

上記発明の明細書（下記の欄でx印がついていない場合は、本意に添付）に、

the specification of which is attached hereto unless the following box is checked:

☐ 一月一日に提出され、米国出願番号または特許協定条約国際出願番号を_____とし、
(該当する場合) _____ に訂正されました。

☒ was filed on March 26, 1998
as United States Application Number or
PCT International Application Number
09/050,182 and was amended on
(if applicable).

私は、特許請求範囲を含む上記訂正後の明細書を検討し、内容を理解していることをここに表明します。

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

私は、遠隔規則法典第37章第1条56項に定義されるとおり、特許資格の有無について重要な情状を提示する義務があることを認めます。

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56.

Page 1 of 3a

Burden Hour Statement: This form is estimated to take 0.4 hours to complete. Time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, Patent and Trademark Office, Washington, DC 20231. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner of Patents and Trademarks, Washington, DC 20231.

Copy

RECEIVED

AUG - 3 2000

IC 1700 MAIL ROOM

Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it displays a valid CMB control number.

Japanese Language Declaration (日本語宣言書)

私は、米国法典第35編119条(a)・(b)項又は365条(b)項に基づき下記の、米国以外の国の少なくとも一か国を指定している特許協力条約365(a)項に基づく国際出願、又は外国での特許出願もしくは発明者権の主張について、外国優先権をここに主張するとともに、優先権を主張している、本出願の前に出願された特許または発明権の外国出願を以下に、特許マークすることによって示しています。

Prior Foreign Application(s)

外国での先行出願
9-094607

(Number)
(番号)

Japan

(Country)
(国名)

(Number)
(番号)

(Country)
(国名)

私は、第35編米国法典119条(e)項に基づいて下記の米国外特許出願規定に記載された権利をここに主張いたします。

(Application No.)
(出願番号)

(Filing Date)
(出願日)

私は、下記の米国法典第35編120条に基づいて下記の特許出願に記載された権利、又は米国を指定している特許協力条約365条(c)に基づき権利をここに主張します。また、本出願の特許請求範囲の内容が米国法典第35編112条第1項又は特許協力条約で規定された方法で先行する米国外特許出願に開示されていない限り、その先行米国外特許出願の日以後で本出願書の日本国内または特許協力条約国系提出日までの特許期間中に入手された、運搬規則法典第37編1条56項で規定された特許資格の有無に関する重要な情報について開示義務があることを認識しています。

(Application No.)
(出願番号)

(Filing Date)
(出願日)

(Application No.)
(出願番号)

(Filing Date)
(出願日)

私は、私自身の知識に基づいて本宣言書で私が行なう表明が真実であり、かつ私の入手した情報と私の信じることに基づき表明が全て真実であると信じていること、さらに故意になされた虚偽の表明及びそれと同等の行為は米国法典第18編第1001条に基づき、罰金または拘禁、もしくはその両方により処罰されること、そしてそのような故意による虚偽の表明を行なえば、出願した、又は後に許可された特許の有効性が失われることを認識し、よってここに上記のごとく宣誓を致します。

I hereby claim foreign priority under Title 35, United States Code, Section 119 (a)-(d) or 365(b) of any foreign application(s) for patent or inventor's certificate, or 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed.

Priority Not Claimed
優先権主張なし

March 27, 1997

(Day/Month/Year Filed)
(出願年月日)

(Day/Month/Year Filed)
(出願年月日)

I hereby claim the benefit under Title 35, United States Code, Section 119(e) of any United States provisional application(s) listed below.

(Application No.)
(出願番号)

(Filing Date)
(出願日)

I hereby claim the benefit under Title 35, United States Code, Section 120 of any United States application(s), or 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of Title 35, United States Code Section 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of application.

(Status: Patented, Pending, Abandoned)
(現況: 特許許可済、係属中、放棄済)

(Status: Patented, Pending, Abandoned)
(現況: 特許許可済、係属中、放棄済)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

No. 01,080

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith (list name and registration number)

Send Correspondence to:

WILLIAM C. BENTLEY
WILLIAM E. RICHARDSON
4000 University Square, Ste. 1400
La Bolla, CA 92037

Direct Telephone Calls to: (Name and telephone number)

電話號碼：(各州均有分機)
Scott C. Everts
(619) 678-5070

Full name of sole or first inventor

唯一または第一発明者

Hideto OHNUMA

Date _____

June 3, 1998

發明者の署名

四寸

Inventor's signature

Residence

住所

Kanagawa, Japan

國產

Citizenship

Japanese

Post Office Address

私書箱

Post Office Address
c/o SEMICONDUCTOR ENERGY LABORATORY CO., LTD.
398, Hase, Atsugi-shi, Kanagawa-ken 243-0036 Japan

Full name of second joint inventor, if any

第二共同発明者

Shunpei YAMAZAKI

Date

June 2, 1998

発明者の署名

目付

Inventor's signature

Residence

仁所

Tokyo, Japan

Citizenship

國產

Japanese

Post Office Address

私書箱

Post Office Address
c/o SEMICONDUCTOR ENERGY LABORATORY CO., LTD.
Kanagawa-ken 243-0036 Japan

c/o SEMICONDUCTOR ENERGY LABORATORY
398, Hase, Atsugi-shi, Kanagawa-ken 243-0036 Japan

(第三以降の共同発明者についても同様に記載し、署名をすること)

(Supply similar information and signature for third and subsequent joint inventors.)

☒ Please see attached page 3a for names, addresses and signatures of additional inventors, if any.

第三共同発明者

Full name of third joint inventor, if any

Setsuo NAKAJIMA

Date

発明者の署名

日付

Inventor's signature

Setsuo Nakajima

June 1, 1998

Residence

住所

Kanagawa, Japan

Citizenship

国籍

Japanese

Post Office Address

私書箱

c/o SEMICONDUCTOR ENERGY LABORATORY CO., LTD.

398, Hase, Atsugi-shi, Kanagawa-ken 243-0036 Japan

第四共同発明者

Full name of fourth joint inventor, if any

Hisashi-OHTANI

Date

発明者の署名

日付

Inventor's signature

Hisashi Ohtani

June 1, 1998

Residence

住所

Kanagawa, Japan

Citizenship

国籍

Japanese

Post Office Address

私書箱

c/o SEMICONDUCTOR ENERGY LABORATORY CO., LTD.

398, Hase, Atsugi-shi, Kanagawa-ken 243-0036 Japan

第五共同発明者

Full name of fifth joint inventor, if any

Inventor's signature

Date

発明者の署名

Residence

住所

Citizenship

国籍

Post Office Address

私書箱

第六共同発明者

Full name of sixth joint inventor, if any

Inventor's signature

Date

発明者の署名

Residence

住所

Citizenship

国籍

Post Office Address

私書箱